

WS4A006065F

Silicon Carbide Schottky Diode

V_{RRM}	=	650	V
$I_F (T_C \leq 130^\circ\text{C})$	=	6	A
Q_C	=	17	nC

Features

- New Thin Wafer Technology
- Low Forward Voltage Drop (V_F)
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on V_F
- Temperature-independent Switching

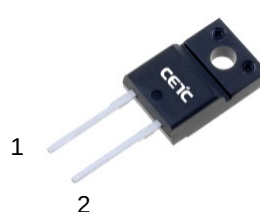
Benefits

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

Applications

- Switch Mode Power Supplies
- Uninterruptible Power Supplies
- Motor drive, PV Inverter, Wind Power Station

Package



TO-220F-2



Part Number	Package	Marking
WS4A006065F	TO-220F-2	WS4A006065F

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	650	V	$T_C = 25^\circ\text{C}$	
V_{RSM}	Surge Peak Reverse Voltage	650	V	$T_C = 25^\circ\text{C}$	
V_R	DC Blocking Voltage	650	V	$T_C = 25^\circ\text{C}$	
I_F	Forward Current	7.5 6	A	$T_C \leq 110^\circ\text{C}$ $T_C \leq 130^\circ\text{C}$	
I_{FSM}	Non-Repetitive Forward Surge Current	50	A	$T_C = 25^\circ\text{C}$, $t_p = 8.3\text{ms}$, Half Sine Wave	
P_{tot}	Power Dissipation	30	W	$T_C = 25^\circ\text{C}$	Fig.3
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to 175	$^\circ\text{C}$		

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.27 1.38	1.5 1.6	V	$I_F = 6A, T_J = 25^{\circ}C$ $I_F = 6A, T_J = 175^{\circ}C$	Fig.1
I_R	Reverse Current	4 20	50 200	μA	$V_R = 650V, T_J = 25^{\circ}C$ $V_R = 650V, T_J = 175^{\circ}C$	Fig.2
C	Total Capacitance	380 39 28	/	pF	$V_R = 0.1V, T_J = 25^{\circ}C, f = 1MHz$ $V_R = 200V, T_J = 25^{\circ}C, f = 1MHz$ $V_R = 400V, T_J = 25^{\circ}C, f = 1MHz$	Fig.5
Q_C	Total Capacitive Charge	17	/	nC	$V_R = 400V, I_F = 6A$ $di/dt = 200A/\mu s, T_J = 25^{\circ}C$	Fig.4

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	5.0	$^{\circ}C/W$	Fig.6
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	80	$^{\circ}C/W$	
T_{solder}	Soldering Temperature	260	$^{\circ}C$	

Typical Performance

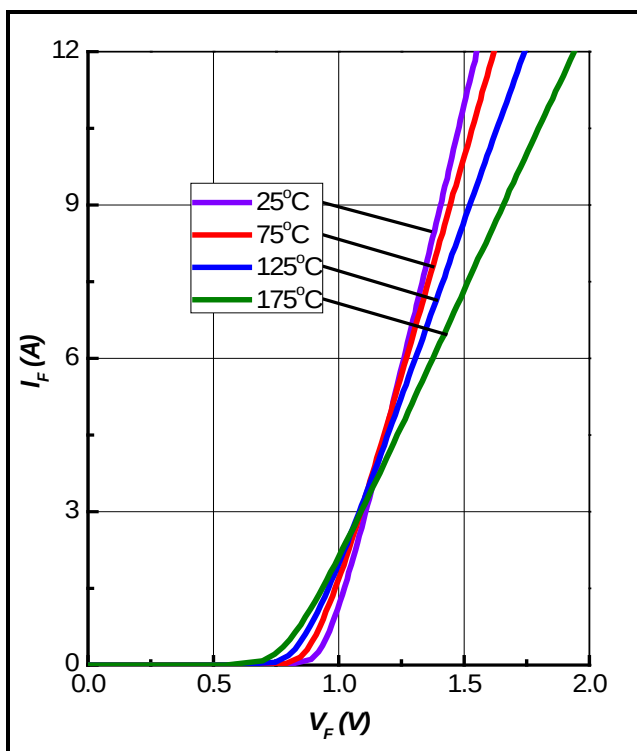


Figure 1. Forward Characteristics

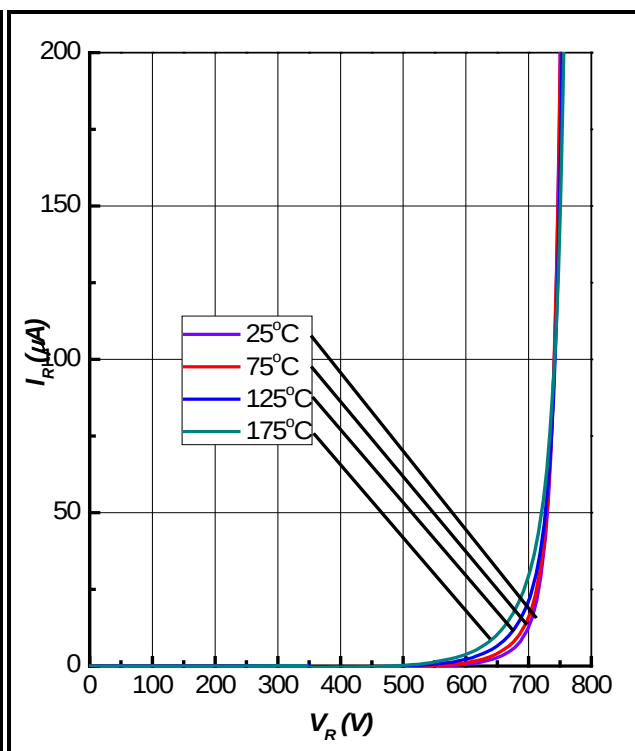


Figure 2. Reverse Characteristics

Typical Performance

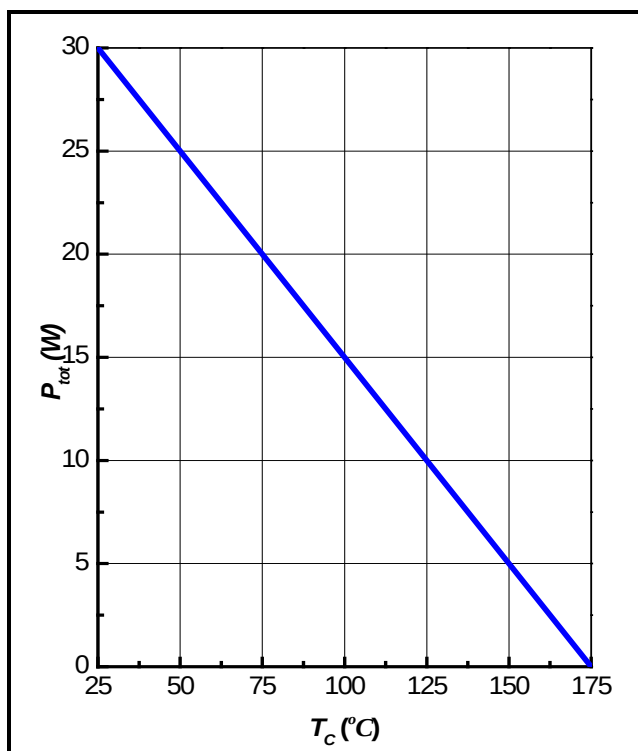


Figure 3. Power Derating

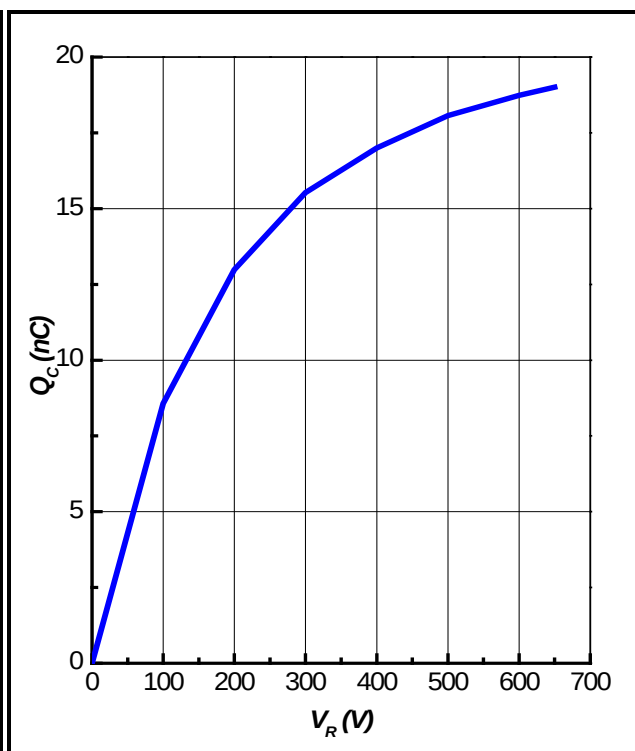


Figure 4. Total Capacitive Charge vs. Reverse Voltage

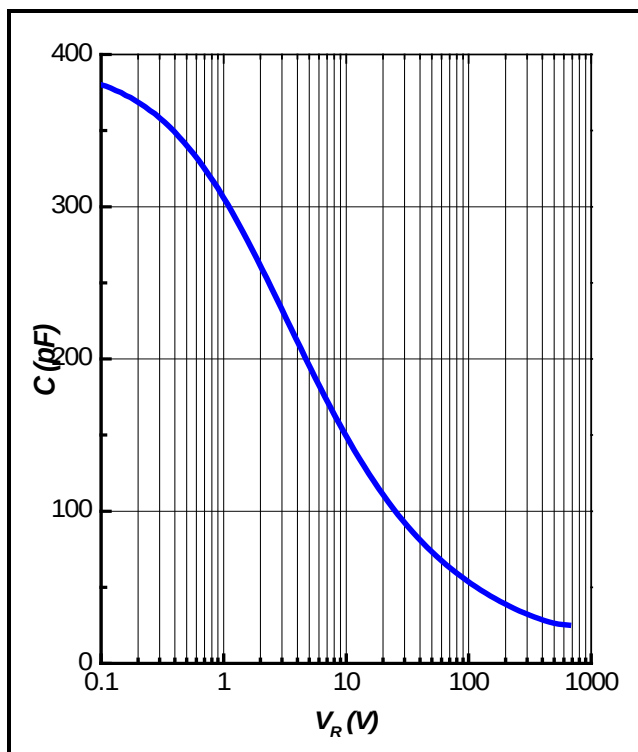


Figure 5. Total Capacitance vs. Reverse Voltage

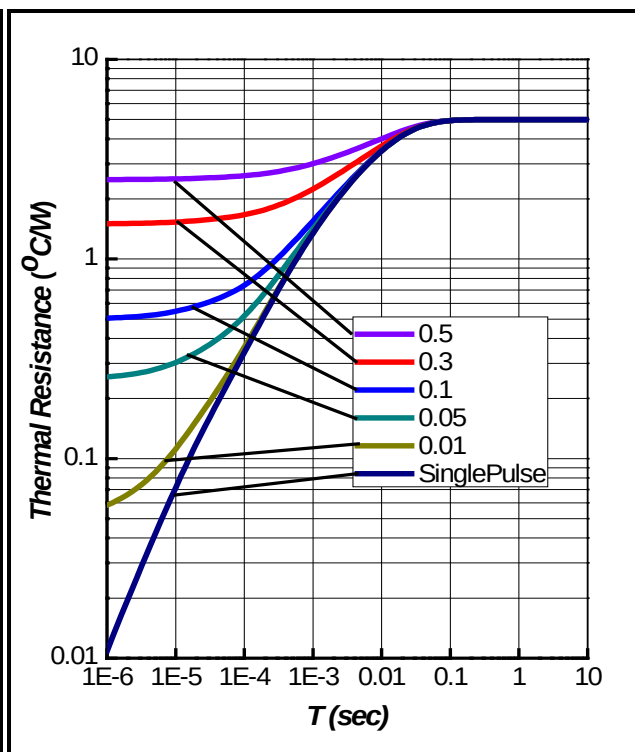
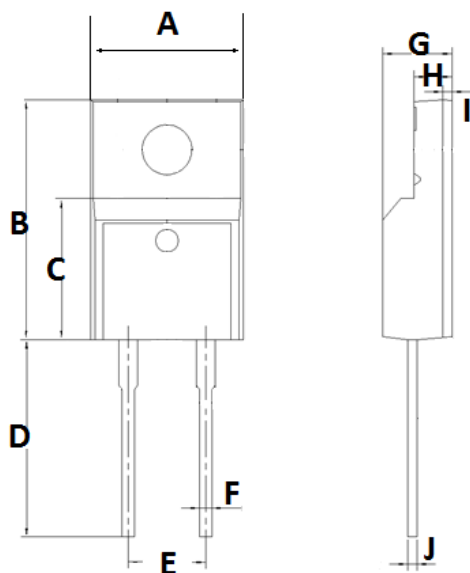


Figure 6. Transient Thermal Impedance

Package Dimensions

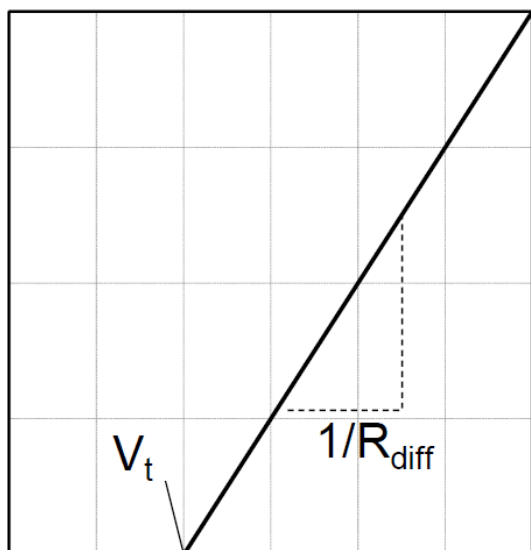
Package TO-220F-2



Symbol	Min. (mm)	Typ. (mm)	Max. (mm)
A	9.90	10.10	10.30
B	15.80	16.00	16.20
C	9.10	9.30	9.50
D	12.90	13.20	13.50
E	4.70	5.00	5.30
F	0.60	0.80	1.00
G	4.55	4.75	4.95
H	2.40	2.60	2.80
I	0.40	0.60	0.80
J	0.42	0.50	0.58

Simplified Diode Model

Equivalent IV Curve for Model



Mathematical Equation

$$V_F = V_t + I_F \times R_{diff}$$

$$V_t = -0.001 \times T_j + 0.99 \text{ [V]}$$

$$R_{diff} = 1.2 \times 10^{-6} \times T_j^2 + 7.2 \times 10^{-5} \times T_j + 0.46 \text{ [\Omega]}$$

Note:

T_j = Diode Junction Temperature In Degrees Celsius,
valid from 25°C to 175°C

I_F = Forward Current

Less than 12A

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